

10072353-X01-XXXXF

S = 0.38 μm GOLD/GXT ON CONTACT AREA

2.0 μ m MIN MATTE TIN ON TAIL

G = 0.76μm GOLD/GXT ON CONTACT AREA
2.0μm MIN MATTE TIN ON TAIL

F = GOLD FLASH ON CONTACT AREA
2.0 μ m MIN MATTE TIN ON TAIL

1.27 μm MIN NICKEL UNDERPLATING

ROHS COMPATIBLE
NOTE 6

PACKAGING

NB OF POSITIONS PER ROW
02 TO 25 PDS



1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR BLACK

2. MATERIAL TERMINAL: COPPER ALLOY

3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW.

4. 7N MIN PIN RETENTION IN EITHER DIRECTION.

5. PACKAGING :

= PLASTIC BOX

U = TUBE AVAILABLE FROM 06 TO 50 PDS
6. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

α - PLATING

"LF" MEANS THE PRODUCT IS LEAD-FREE
2µm MINIMUM MATTE TIN OVER 127µm
MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 30 SECONDS MAX IN A CONVECTION, INRA-RED DR VAPOR PHASE OR REFLOW OVEN.

C - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920.

d - THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-47-0004

www.fciconnect.com		surface -		tolerance std		projection		mm	
		ISO 1302		ISO 406 ISO 1101					
		TOLERANCES UNLESS OTHERWISE SPECIFIED						Scale	
Dr	L MULIN	ANGULAR		0x		± 0.13		A3	
Eng	J COMPAGNON	LINEAR		0.0xx		± 0.05		5:1	
Chr	-	0° ±2°		0.0xx		±-		ECN -	
Appr	JMC	06.09.14		Product family		Mintek		Spec ref	
UNSHR HEADER		RIGHT ANGLE PIP		QC dwg		10072353		Rev.	
catalog no		-		CUSTOMER Drawing		sheet 1 of 1		C	

